ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved uninternational and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1					Form Type Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	ials and Mfg Information			
Supplie	r Information														
Company name*			Company un	Company unique ID			Unique ID Authority					Response Date*			
onsemi												2024-04-27			
Contact N	ame	Title - Contact]	Phone - Contact*					Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
Authorize	d Representative*	Title - Representative]	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective D	ve Date Version Manufacturing Si		ng Site	Weight*		UOM	Unit Type	
		HMHA2801B 4SO TR		4SO TR		2024-04-27		,		ТНН		5	4.749	mg	Each
Manufa	cturing Proccess Informa	tion												·	
	Terminal Plating / Grid Array Ma	Terminal Base Alloy J-STD-020 MS		L Rating	Peak Process Body Tempera		ture Max Time at Peak Tempo		Temperat	ire Num	ber of Reflow Cyc	les			
Matte Tin (Sn) - annealed		CU Alloy 1			245	245 C		30	30 seco		ds 3				
Comments															
vel 1 - m	aximum time at peak temperatu	ire during sol	dering is 10-3	30 seconds											
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	geneous Material Weight Unit of Measure Level S		Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.267	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0864	mg
			Supplier	Silicon (Si)	7440-21-3		0.1754	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0052	mg
Die Attach	0.021	mg	Supplier	Silver (Ag)	7440-22-4		0.0172	mg
			Supplier	Dicyandiamine	461-58-5		0.0002	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0036	mg
Lead Frame	13.225	mg	Supplier	Silver (Ag)	7440-22-4		0.6784	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0238	mg
			Supplier	Iron (Fe)	7439-89-6		0.3253	mg
			Supplier	Copper (Cu)	7440-50-8		12.1789	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0185	mg
Mold Compound-White	31.422	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		7.8555	mg
			В	Brominated Bisphenol A Diglycidyl Ethe	er 40039-93-8		0.9427	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.242	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.9427	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		15.711	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.7282	mg
Plating	0.961	mg	Supplier	Tin (Sn)	7440-31-5		0.961	mg
Protective Coating	8.8	mg	Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		4.4	mg
			Supplier	Ethylbenzene	100-41-4		0.88	mg
			Supplier	Filler (SiO2)	68909-20-6		1.672	mg
			Supplier	Misc.	Proprietary Data		0.088	mg
			Supplier	Xylene	1330-20-7		1.76	mg
Wire Bond - Au	0.053	mg	Supplier	Gold (Au)	7440-57-5		0.053	mg